

C0603C362J1GACTU

Aliases (C0603C362J1GAC7867) SMD Comm C0G, Ceramic, 3,600 pF, 5%, 100 VDC, C0G, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0603, 0.5 mm



Click here for the 3D model.

0603

1.6mm +/-0.15mm

0.8mm +/-0.15mm

0.8mm +/-0.07mm

0.35mm +/-0.15mm

T&R, 180mm, Paper Tape

0.5mm MIN

4000

| General Information | |
|--------------------------|---|
| Series | SMD Comm COG |
| Style | SMD Chip |
| Description | SMD, MLCC, Ultra-Stable, Low Loss, Class I |
| Features | Ultra-Stable, Low Loss, Class I |
| RoHS | Yes |
| Termination | Tin |
| Marking | No |
| AEC-Q200 | No |
| Typical Component Weight | 3.7 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| | Specifications | |
|---|--|------------------------|
| | Capacitance | 3,600 pF |
| | Measurement Condition | 1 kHz 1.0Vrms |
| | Tolerance | 5% |
| | Voltage DC | 100 VDC |
| | Dielectric Withstanding Voltage | 250 VDC |
| | Temperature Range | -55/+125°C |
| | Temp. Coefficient | COG |
| 2 | Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 30 ppm/C, 1kHz 1.0Vrms |
| | Dissipation Factor | 0.1% 1 kHz 1.0Vrms |
| | Aging Rate | 0% Loss/Decade Hour |
| | Insulation Resistance | 100 GOhms |

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Dimensions

Packaging Specifications

Packaging Quantity

Chip Size

L

W T

s

В

Packaging